

#### **DATA SHEET**

# SKY66002-11: 1900 to 2025 MHz, +19 dBm Linear **Power Amplifier**

#### **Applications**

- Residential femtocells
- WCDMA, Band 2
- Small cells

#### **Features**

- Small signal gain: 29 dB
- ACLR at Pout = +19 dBm: -50 dBc
- PA on/off control
- I/O impedance internally matched to 50 Q
- Single DC supply: 3.3 V to 4.6 V
- Minimal number of external components require
- Small footprint MCM (10-pin, 3 x 3 mm) package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to Skyworks Definition of Green<sup>™</sup>, document number SQ04-0074.

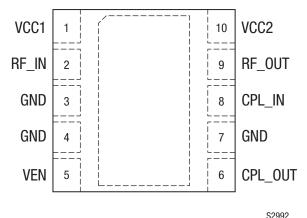


Figure 1. SKY66002-11 Pinout (Top View)

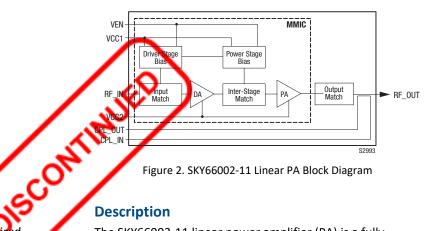


Figure 2. SKY66002-11 Linear PA Block Diagram

# Description

The SKY66002-11 linear power amplifier (PA) is a fully matched surface-mount module developed for WCDMA applications operating from 1900 to 2025 MHz. The device meets the stringent spectral linearity requirements of WCDMA femtocell applications with high power-added efficiency. An integrated directional coupler eliminates the need for any external coupler.

The GaAs MMIC contains all active amplifier circuitry, which includes input and interstage matching circuits. An output match into a 50  $\Omega$  load, realized off-chip within the module package, optimizes efficiency and power performance.

The SKY66002-11 is manufactured with Skyworks InGaP GaAs HBT process, which provides for all positive voltage DC supply operation and maintains high efficiency and good linearity. The primary bias to the device can be supplied directly from any suitable power supply with an output of 4.2 V. Power down is achieved by setting the VEN pin to 0 V. No external supply side switch is needed since typical "off" leakage is a few microamps with full primary voltage supplied from the main power supply.

The SKY66002-11 is packaged in a 10-pin, 3 x 3 mm Multi-Chip Module (MCM), which allows for a highly manufacturable low-cost solution.

A functional block diagram of the SKY66002-11 is shown in Figure 1. The 10-pin MCM package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY66002-11 Signal Descriptions

Pin	Name	Description	Pin	Name	Description	
1	VCC1	Input stage supply voltage	6	CPL_OUT	RF coupler output	
2	RF_IN	RF input port	7	GND	Ground	
3	GND	Ground	8	CPL_IN	RF coupler input	
4	GND	Ground	9	RF_OUT	RF output port	
5	VEN	Enable	10	VCC2	Output stage supply voltage	

#### **Technical Description**

The SKY66002-11 PA contains all of the needed RF matching and DC biasing circuits. The device is a two-stage, HBT InGaP device optimized for high linearity and power efficiency. These features make the device suitable for wideband digital applications where PA linearity and power consumption are of critical importance (e.g., small cell and infrastructure applications).

The device is designed for standard WCDMA modulated signals. Under these stringent test conditions, the device exhibits excellent spectral purity and power efficiency.

## **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY66002-11 are provided in Table 2. The recommended operating conditions are specified in Table 3 and electrical specifications are provided in Table 4.

Typical performance characteristics of the SKY66002-11 are illustrated in Figures 3 to 9.

Table 2. SKY66002-11 Absolute Maximum Ratings<sup>1</sup>

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage (VCC1, VCC2)	Vcc	0	+4.6	V
Total supply current	Icc		700	mA
Logic control input voltage (VEN)	VCTL	-0.5	3.1	V
Case operating temperature <sup>2</sup>	Tc	-40	+85	°C
Storage temperature	Tstg	-55	+150	°C
Junction temperature	TJ		+150	°C
Thermal resistance	Өлс		60	°C/W
Electrostatic discharge:	ESD			
Charged Device Model (CDM), Class 4 Human Body Model (HBM), Class 1C Machine Model (MM), Class B			1000 1000 200	V V V

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING**: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

 $<sup>^{\,2}\,</sup>$  Case operating temperature (Tc) refers to the temperature of the bottom ground pad.

Table 3. SKY66002-11 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Мах	Units
Frequency range	f	1900		2025	MHz
Supply voltage (VCC1, VCC2) <sup>1</sup>	Vcc	4.0	4.2	4.6	V
Logic control input voltage: Logic high Logic low	VIH VIL	1.35 0	1.80	3.10 0.5	V V
PA enable current	IEN			<1	mA
Case operating temperature	Тс	-20	+25	+85	°C

<sup>1</sup> Voltage levels measured at the pads of the package. The Evaluation Board supply voltage levels may be different. Refer to the Evaluation Board schematic diagram in this data sheet.

Table 4. SKY66002-11 Electrical Specifications<sup>1</sup>

(VCC1 = VCC2 = +4.2 V, Tc = +25 °C, f = 1960 MHz, Characteristic Impedance [Zo] = 50 Ω, VEN = "1," Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Small signal gain	S21	CW, PIN = -20 dBm	27.5	29.0		dB
Input return loss	S11	CW, PIN = -20 dBm	20	28		dB
Quiescent current	Icq	No RF		60	65	mA
Operating current	Icc	CW, POUT = +19 dBm		133	150	mA
Power-down current	IPD C	VEN = "0"		0.5	1.0	μА
Adjacent channel leakage ratio	ACLR5	@5 MHz offset, WCDMA test model 1, with 64 DPCH, POUT = +19 dBm		-52.5	-47.0	dBc
Error vector magnitude	EVM	POUT = +19 dBm		1.2	2.0	%
Harmonic suppression	2fo 3fo	CW, Pout = +19 dBm		-45 -49	-41 -45	dBc dBc
Third order output intercept point	OIP3	+19 dBm/tone, frequency separation = 5 MHz	+38.0	+43.5		dBm
Input coupling factor	CPLIN			-20.5		dB
Output coupling factor	СРЬООТ			-22.0		dB
Stability (non-harmonic spurious)	VSWRSTABILIT Y	VSWR = 6:1		-70		dBc
Maximum ruggedness input power	PIN_RUG	VSWR = 6:1		-7		dBm

Performance is guaranteed only under the conditions listed in this table. Both pins 6 and 8 (CPL\_OUT and CPL\_IN, respectively) should be terminated with 50 Ω.

## **Typical Performance Characteristics**

 $(VCC1 = VCC2 = +4.2 \text{ V}, Tc = +25 ^{\circ}C, f = 1960 \text{ MHz}, Characteristic Impedance [Zo] = 50 <math>\Omega$ , VEN = "1," Unless Otherwise Noted)

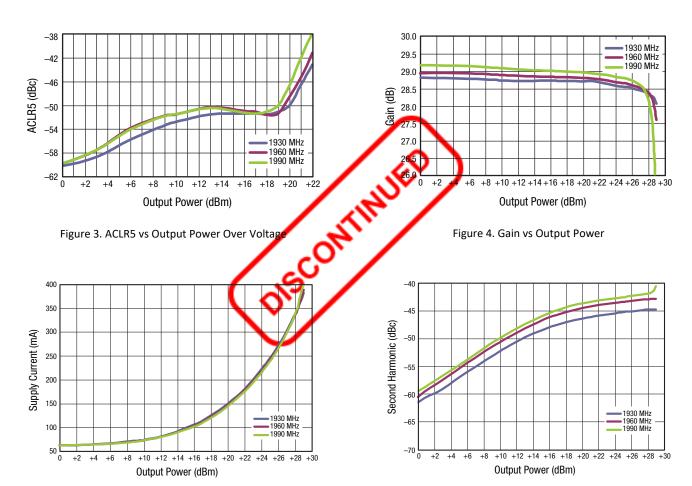


Figure 5. Supply Current vs Output Power

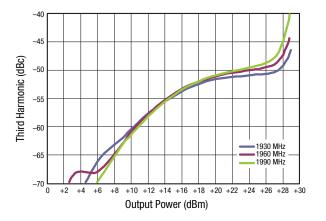


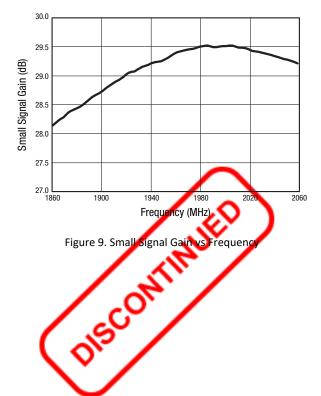
Figure 7. Third Harmonic vs Output Power



Figure 6. Second Harmonic vs Output Power

Figure 8. Input Return Loss vs Frequency

Frequency (MHz)



# **Evaluation Board Description**

The SKY66002-11 Evaluation Board is used to test the performance of the SKY66002-11 PA. A schematic diagram of the Evaluation Board is shown in Figure 10.

An assembly drawing for the Evaluation Board is shown in Figure 11, and the layer detail is provided in Figure 12.

6

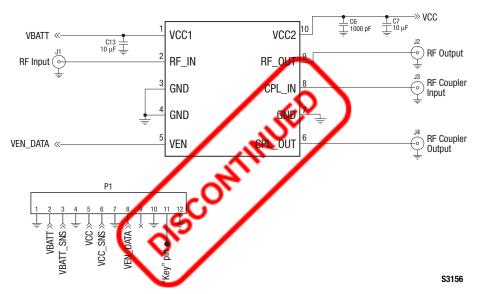


Figure 10. SKY66002-11 Evaluation Board Schematic

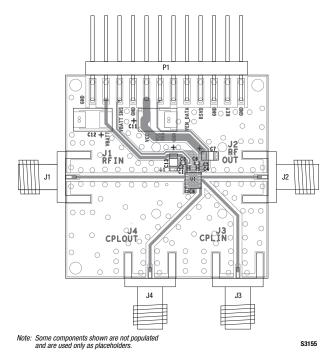
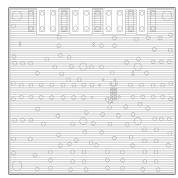


Figure 11. SKY66002-11 Evaluation Board Assembly Diagram



Layer 3: Ground



Layer 4: Bottom (Ground) Layer

S315

Figure 12. SKY66002-11 Evaluation Board Layer Detail

#### **Package Dimensions**

The PCB layout footprint for the SKY66002-11 is provided in Figure 13. Typical part markings are shown in Figure 14. Figure 15 shows the package dimensions, and Figure 16 provides the tape and reel dimensions.

#### **Package and Handling Information**

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY66002-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

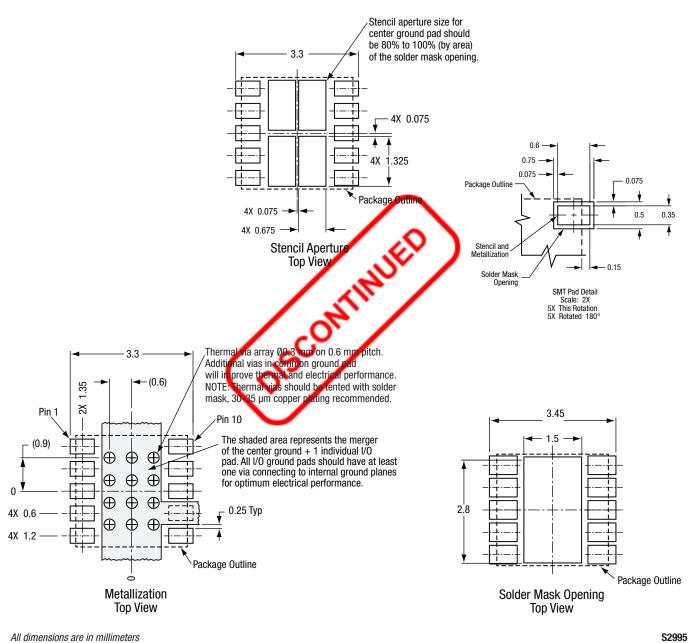


Figure 13. PCB Layout Footprint for the SKY66002-11

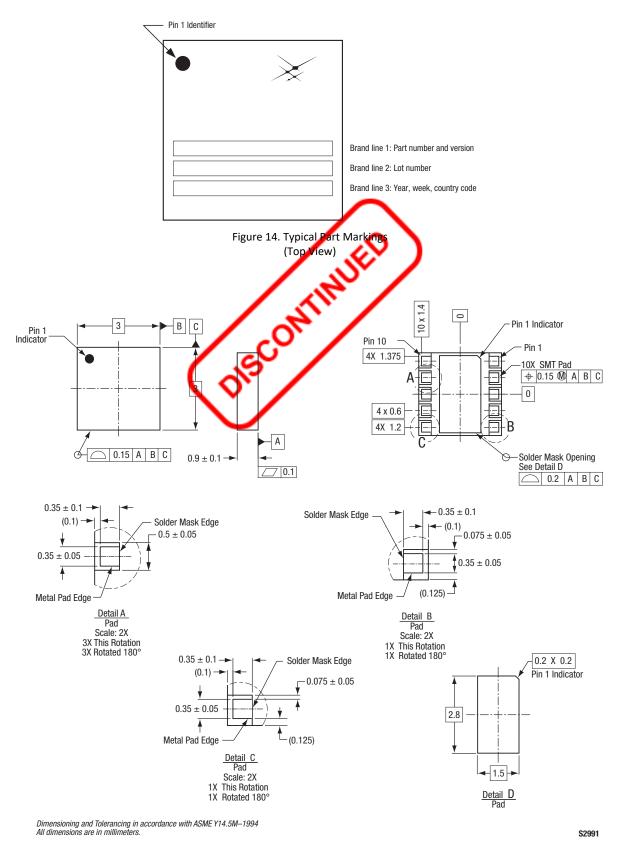
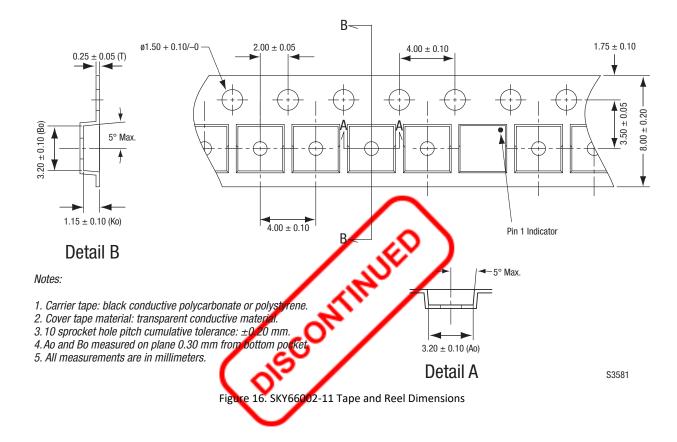


Figure 15. SKY66002-11 Package Dimensions



## **Ordering Information**

Product Description	Product Part Number	Evaluation Board Part Number
SKY66002-11 Linear PA	SKY66002-11	SKY66002-11-EVB



Copyright © 2012-2013, 2017, 2024, Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks' Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of Skyworks' published specifications or parameters.

Skyworks, the Skyworks symbol, Sky5°, SkyOne°, SkyBlue™, Skyworks Green™, ClockBuilder°, DSPLL°, ISOmodem°, ProSLIC°, SiPHY°, and RFeIC° are trademarks or registered trademarks of Skyworks Solutions, Inc. or its subsidiaries in the United States and other countries. Third-party brands and names are for identification purposes only and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.